



Features

- Lead free as standard
- RoHS compliant*
- Leadless
- Low stored charge



This series is currently available but not recommended for new designs.

CD0603/1005 Schottky Barrier Chip Diode Series

General Information

The markets of portable communications, computing and video equipment are challenging the semiconductor industry to develop increasingly smaller electronic components.

Bourns offers small-signal high-speed Schottky Barrier Diodes for switching and rectification applications, in compact chip package 0603 and 1005 size format, which offer PCB real estate savings and are considerably smaller than most competitive parts. The Schottky Barrier Diodes offer a forward current of 30 mA, 100 mA or 200 mA, a reverse voltage of 30 V and 40 V and also have a low forward voltage option. The diodes are lead free with Cu/Ni/Au plated terminations and are compatible with lead free manufacturing processes, conforming to many industry and government regulations on lead free components.

Bourns® Chip Diodes conform to JEDEC standards, easy to handle on standard pick and place equipment and their flat configuration makes roll away much more difficult.

Electrical Characteristics (@ T_A = 25 °C Unless Otherwise Noted)

Parameter	Symbol	CDxxx-B00340	CDxxx-B0130L	CDxxx-B0140L	CDxxx-B0140R	CDxxx-B0230	CDxxx-B0240	Unit
Forward Voltage (Max.)	V _F	0.37 (I _f = 1 mA)	0.44 (I _f = 0.1 A)	0.55 (I _f = 0.1 A)	0.45 (I _f = 0.01 A)	0.50 (I _f = 0.2 A)	0.55 (I _f = 0.2 A)	V
Capacitance Between Terminals (Max.) (f = 1 MHz)	C _T	1.5 (V _r = 1 V)	9 (V _r = 10 V)	9 (V _r = 10 V)	9 (V _r = 10 V)	12 (V _r = 10 V)	12 (V _r = 10 V)	pF
Reverse Current (Max.)	I _R	1 (V _r = 40 V)	30 (V _r = 30 V)	30 (V _r = 10 V)	1 (V _r = 10 V)	30 (V _r = 30 V)	10 (V _r = 30 V)	μA

How To Order

CD 0603 - B 01 30 L

Common Code _____
Chip Diode

Package _____
• 0603
• 1005

Model _____
B = Schottky Barrier Series

Average Forward Current (I_o) Code _____
003 = 30 mA
01 = 100 mA
02 = 200 mA
(Code x 1000 mA = Average Forward Current)

Reverse Voltage (V_R) Code _____
30 = 30 V
40 = 40 V

Forward Voltage Suffix _____
L = Low Forward Voltage V_f (CDxxx-B0130L)
R = Low Reverse Current V_R (CDxxx-B0140R)

CD0603/1005 Schottky Barrier Chip Diode Series

BOURNS®

Absolute Ratings (@ $T_A = 25^\circ\text{C}$ Unless Otherwise Noted)

Parameter	Symbol	CD0603-B00340	CD0603-B0130L	CD0603-B0140L	CD0603-B0140R	CD0603-B0230	CD0603-B0240	Unit
Repetitive Peak Reverse Voltage	V_{RRM}	45	35	45	45	35	45	V
Reverse Voltage	V_R	40	30	40	40	30	40	V
Average Forward Current	I_O	30	100	100	100	200	200	mA
Forward Current, Surge Peak	I_{surge}	500*	1000*	1000*	1000*	2000*	2000*	mA
Power Dissipation	PD		150					mW
Storage Temperature	T_{STG}		-40 to +125					$^\circ\text{C}$
Junction Temperature	T_J		-40 to +125					$^\circ\text{C}$

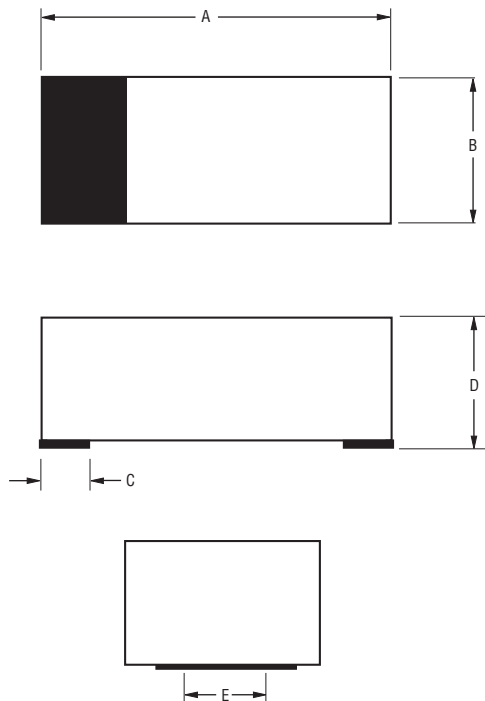
Parameter	Symbol	CD1005-B00340	CD1005-B0130L	CD1005-B0140L	CD1005-B0140R	CD1005-B0230	CD1005-B0240	Unit
Repetitive Peak Reverse Voltage	V_{RRM}	45	35	45	45	35	45	V
Reverse Voltage	V_R	40	30	40	40	30	40	V
Average Forward Current	I_O	30	100	100	100	200	200	mA
Forward Current, Surge Peak	I_{surge}	500*	1000*	1000*	1000*	3000*	3000*	mA
Power Dissipation	PD	200	250	250	250	250	250	mW
Storage Temperature	T_{STG}		-40 to +125					$^\circ\text{C}$
Junction Temperature	T_J		-40 to +125					$^\circ\text{C}$

* Condition: 8.3 ms single half sine-wave superimposed on rate load (JEDEC method).

CD0603/1005 Schottky Barrier Chip Diode Series

BOURNS®

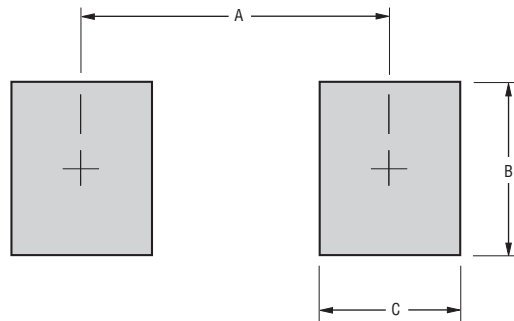
Product Dimensions



Dimension	0603	1005
A	$\frac{1.60 - 1.80}{(0.063 - 0.071)}$	$\frac{2.40 - 2.60}{(0.095 - 0.102)}$
B	$\frac{0.80 - 1.00}{(0.031 - 0.039)}$	$\frac{1.10 - 1.30}{(0.043 - 0.051)}$
C	$\frac{0.45}{(0.018)}$ Typ.	$\frac{0.50}{(0.020)}$ Typ.
D	$\frac{0.70 - 0.85}{(0.027 - 0.033)}$	$\frac{0.70 - 0.90}{(0.027 - 0.035)}$
E	$\frac{0.70}{(0.028)}$ Typ.	$\frac{1.00}{(0.039)}$ Typ.

DIMENSIONS: $\frac{\text{MM}}{(\text{INCHES})}$

Recommended Pad Layout



Dimension	0603	1005
A (Max.)	$\frac{1.25}{(0.049)}$	$\frac{2.00}{(0.079)}$
B (Min.)	$\frac{1.00}{(0.039)}$	$\frac{1.3}{(0.051)}$
C (Min.)	$\frac{0.6}{(0.024)}$	$\frac{0.7}{(0.028)}$

DIMENSIONS: $\frac{\text{MM}}{(\text{INCHES})}$

Physical Specifications

Case0603(1608) / 1005(2512) Molded plastic
 Terminals.....Gold plated, solderable per MIL-STD-750,
 Method 2026
 PolarityIndicated by cathode band
 Mounting PositionAny
 Weight0.000159 ounces / 0.0045 grams

Typical Part Marking

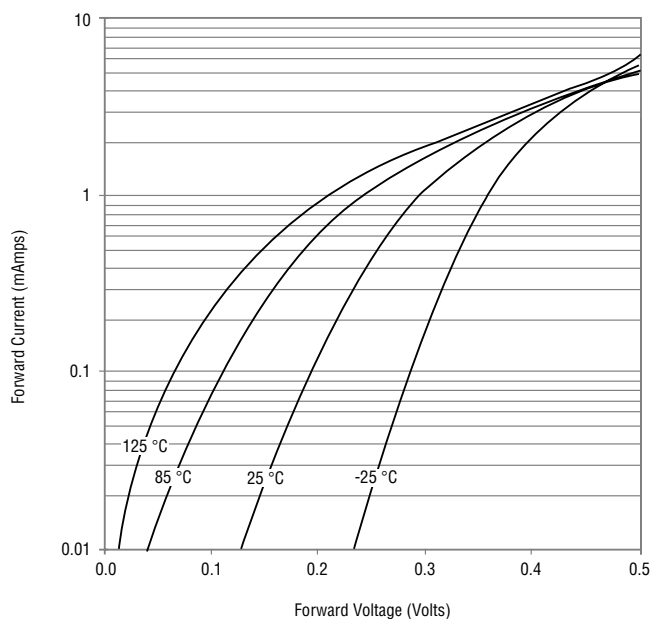
CDxxxx-B00340B2
 CDxxxx-B0130LB3
 CDxxxx-B0140LB8
 CDxxxx-B0140R.....B9
 CDxxxx-B0230B5
 CDxxxx-B0240B7

CD0603/1005 Schottky Barrier Chip Diode Series

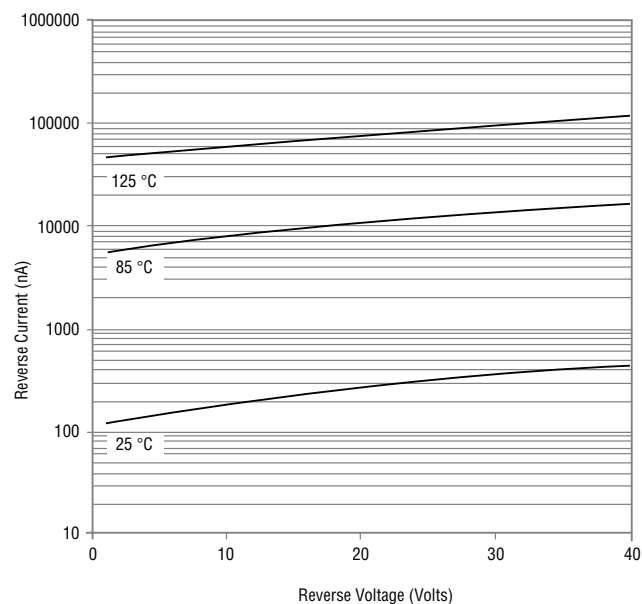
BOURNS®

Rating and Characteristic Curves: CDxxx-B00340

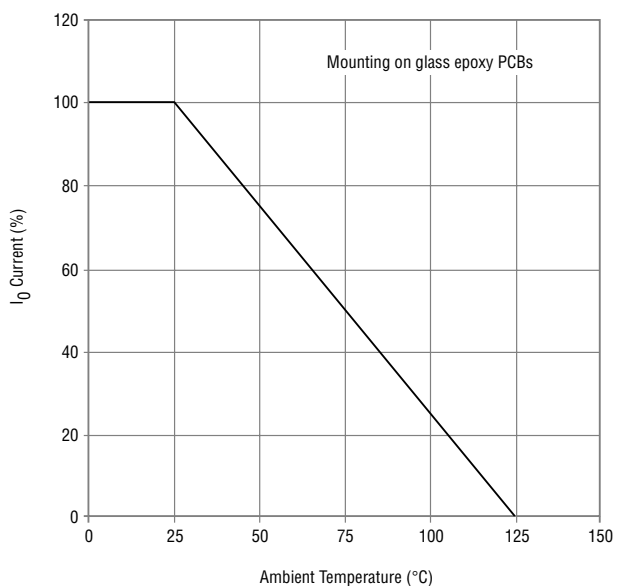
Forward Characteristics



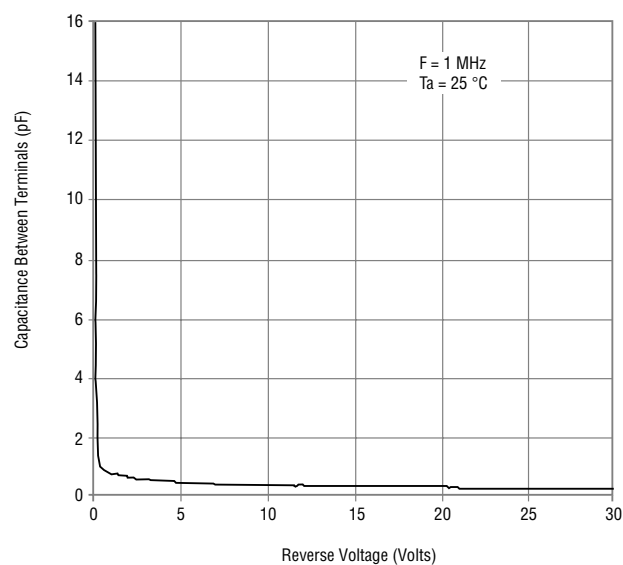
Reverse Characteristics



Derating Curve



Capacitance Between Terminals

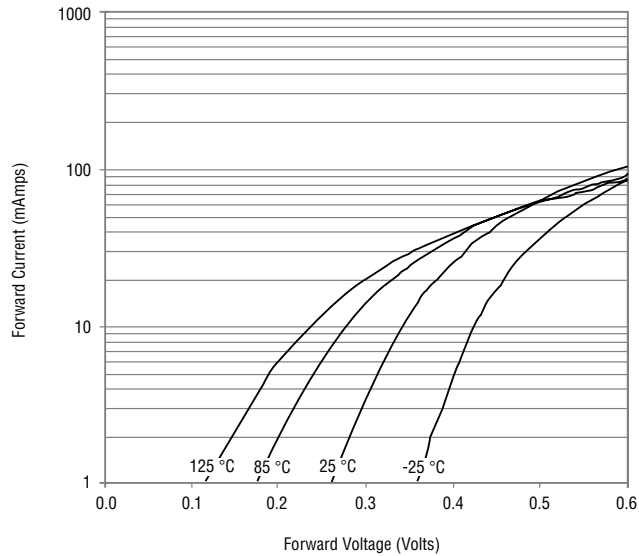


CD0603/1005 Schottky Barrier Chip Diode Series

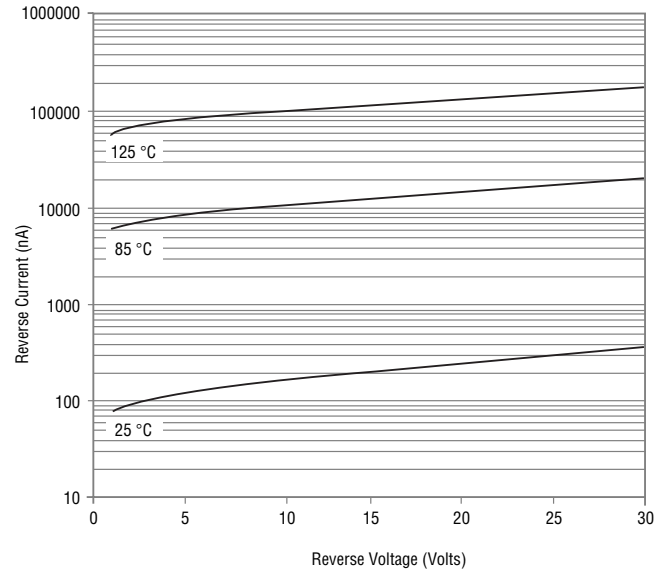
BOURNS®

Rating and Characteristic Curves: CDxxxx-B0130L

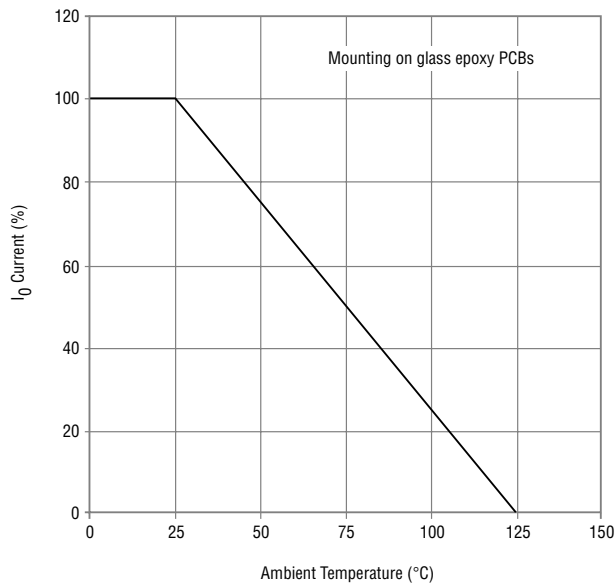
Forward Characteristics



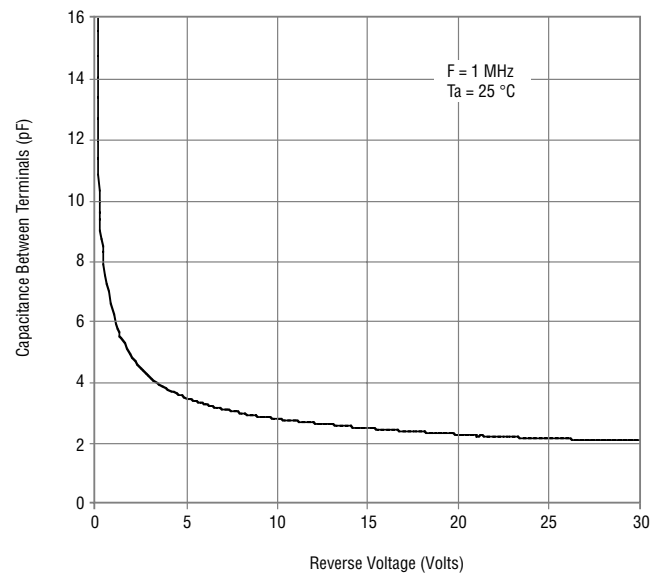
Reverse Characteristics



Derating Curve



Capacitance Between Terminals

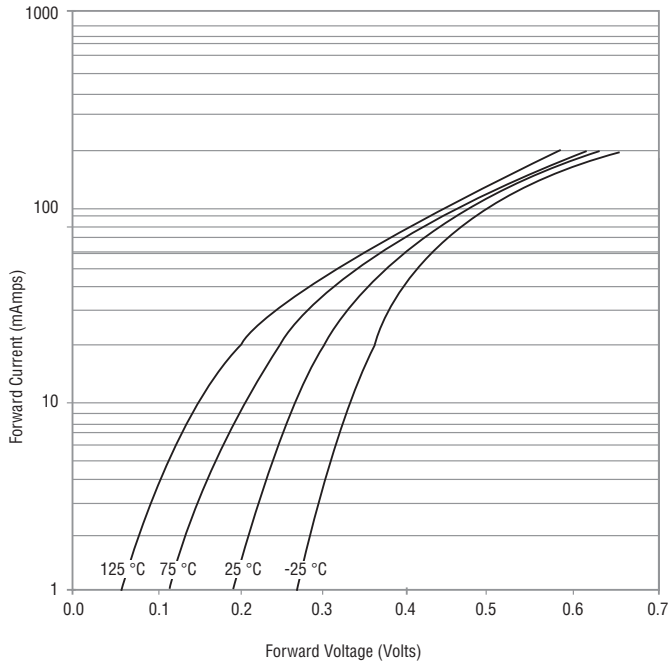


CD0603/1005 Schottky Barrier Chip Diode Series

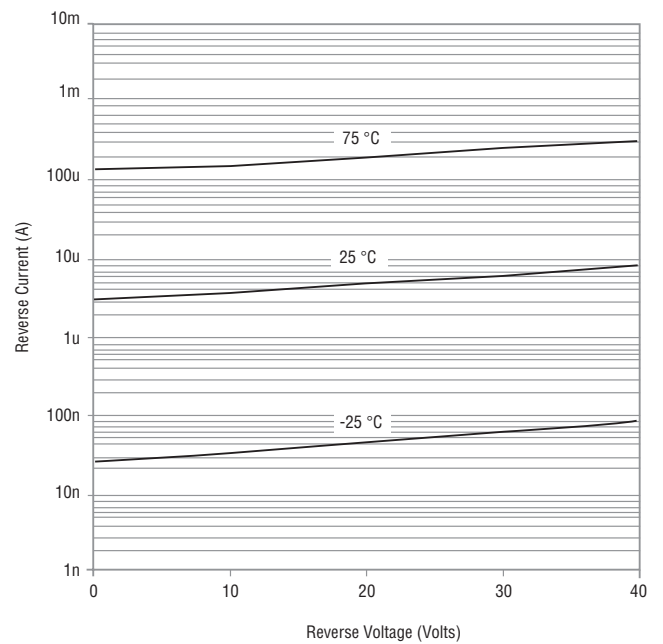
BOURNS®

Rating and Characteristic Curves: CDxxxx-B0140L

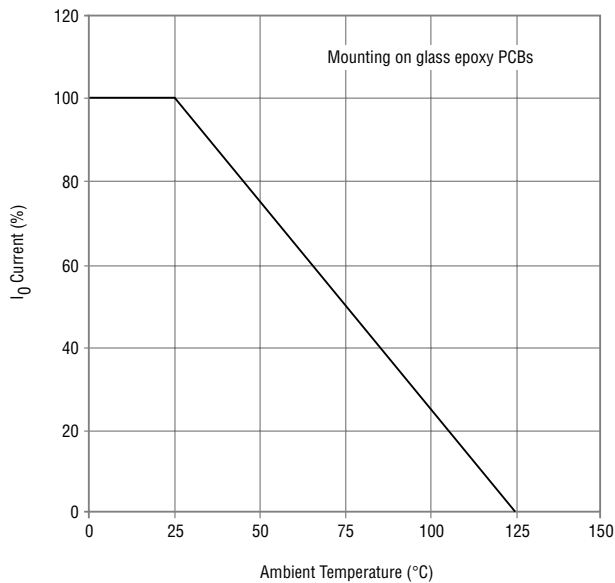
Forward Characteristics



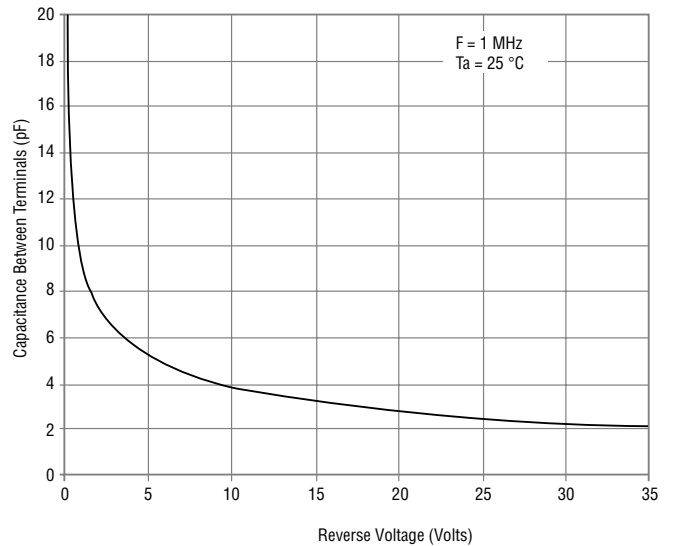
Reverse Characteristics



Derating Curve



Capacitance Between Terminals



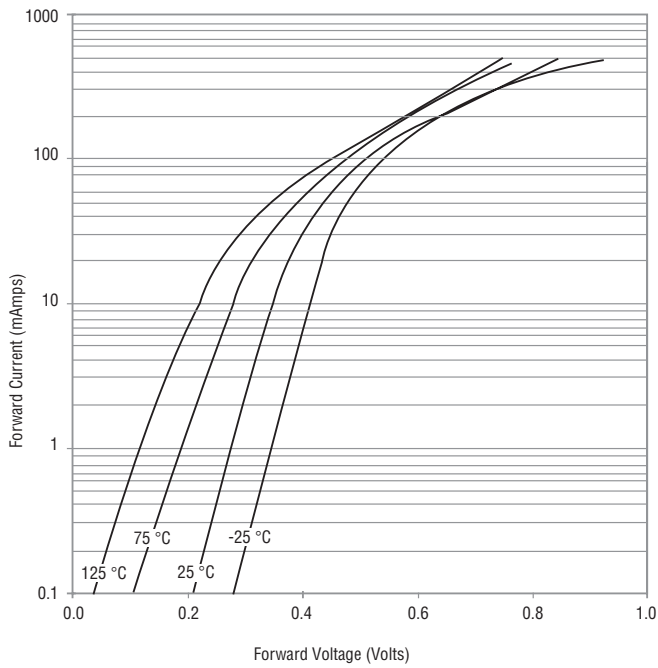
Specifications are subject to change without notice.
Customers should verify actual device performance in their specific applications.

CD0603/1005 Schottky Barrier Chip Diode Series

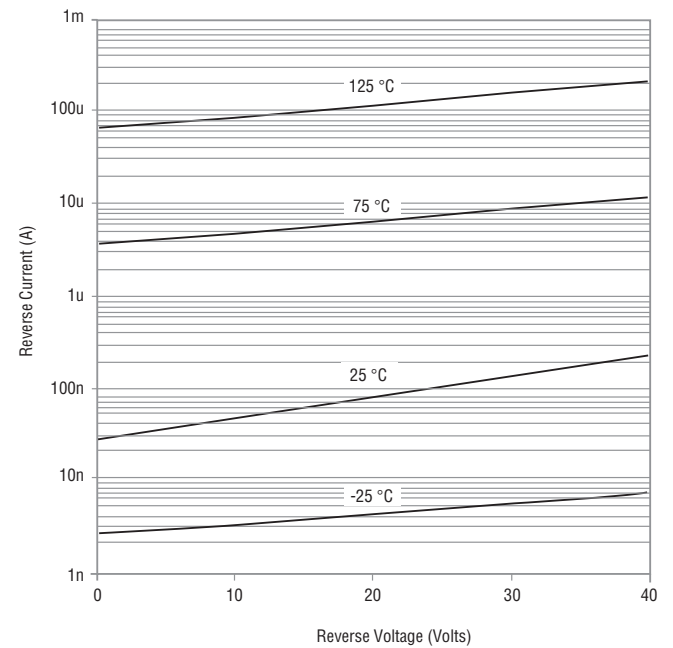
BOURNS®

Rating and Characteristic Curves: CDxxxx-B0140R

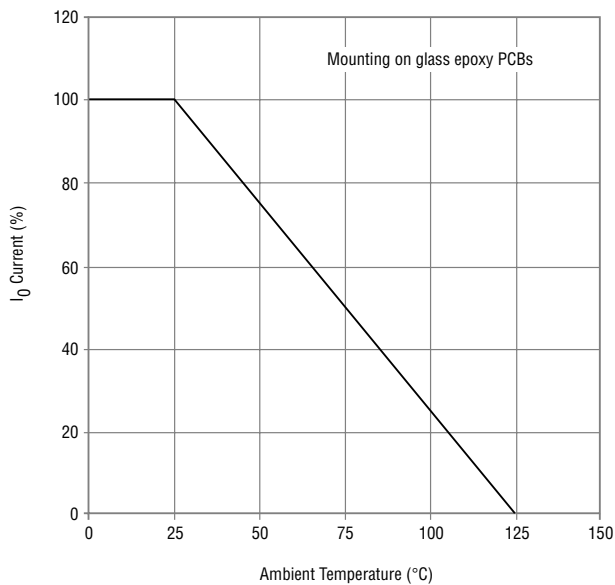
Forward Characteristics



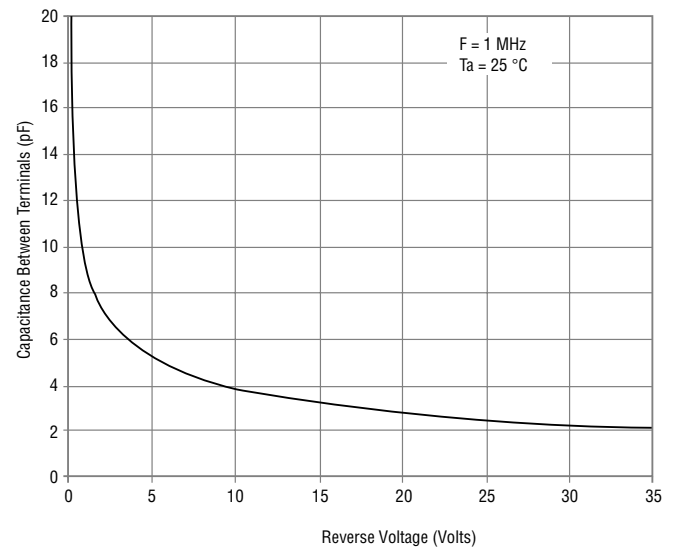
Reverse Characteristics



Derating Curve



Capacitance Between Terminals



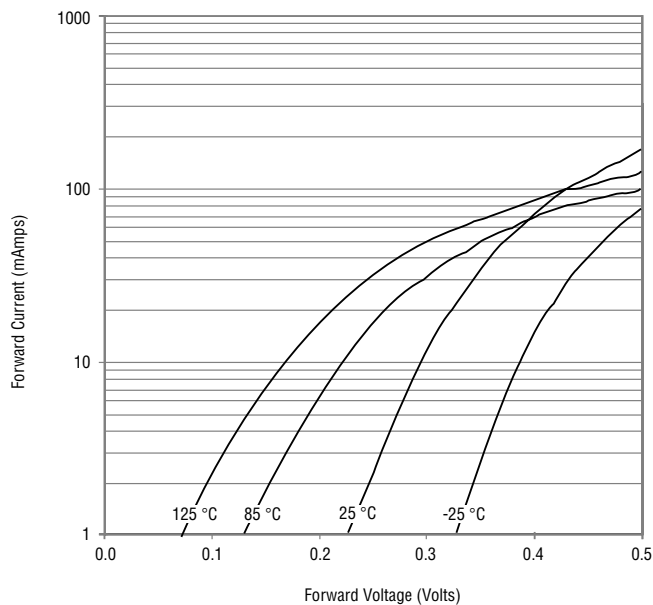
Specifications are subject to change without notice.
Customers should verify actual device performance in their specific applications.

CD0603/1005 Schottky Barrier Chip Diode Series

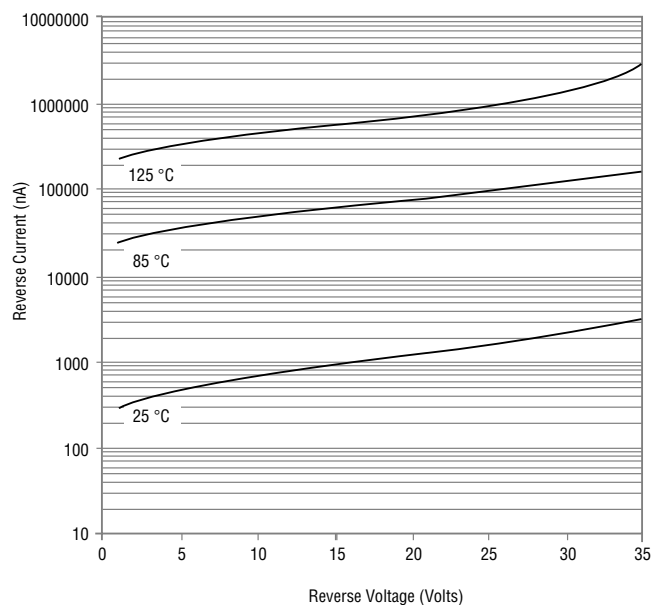
BOURNS®

Rating and Characteristic Curves: CDxxx-B0230

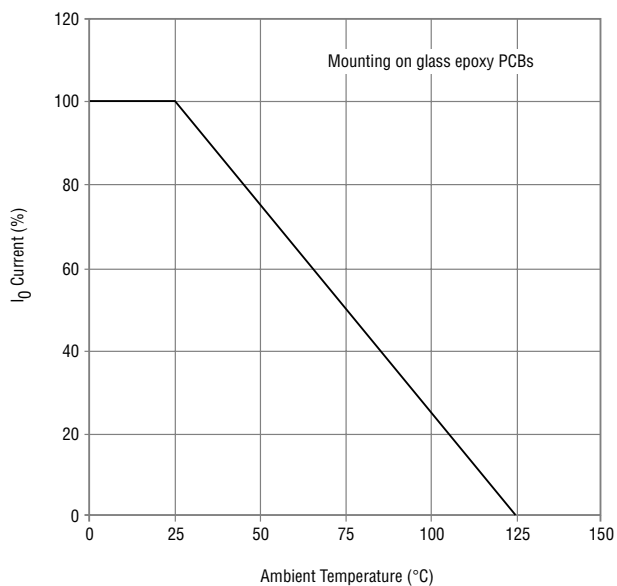
Forward Characteristics



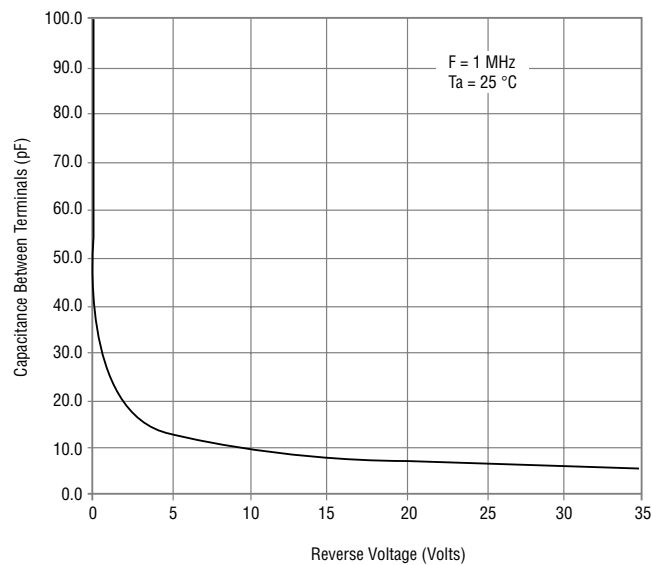
Reverse Characteristics



Derating Curve



Capacitance Between Terminals

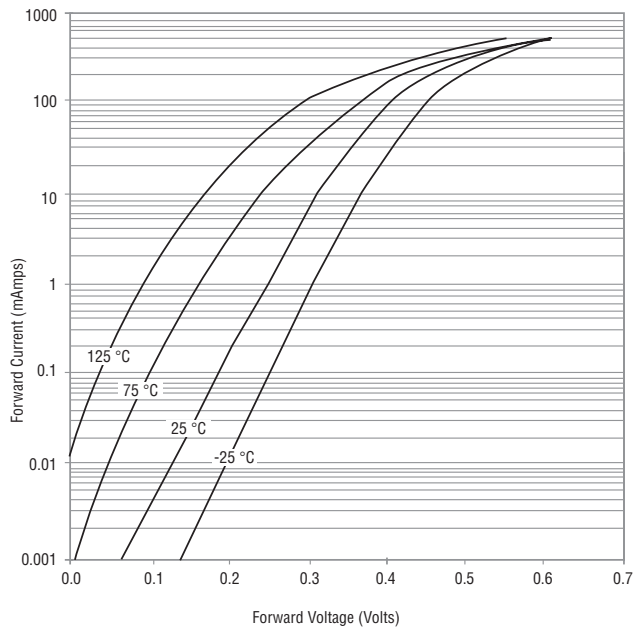


CD0603/1005 Schottky Barrier Chip Diode Series

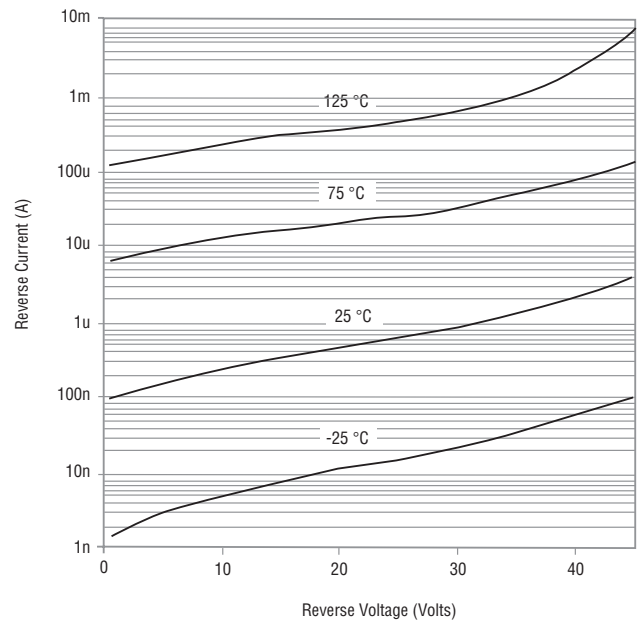
BOURNS®

Rating and Characteristic Curves: CDxxxx-B0240

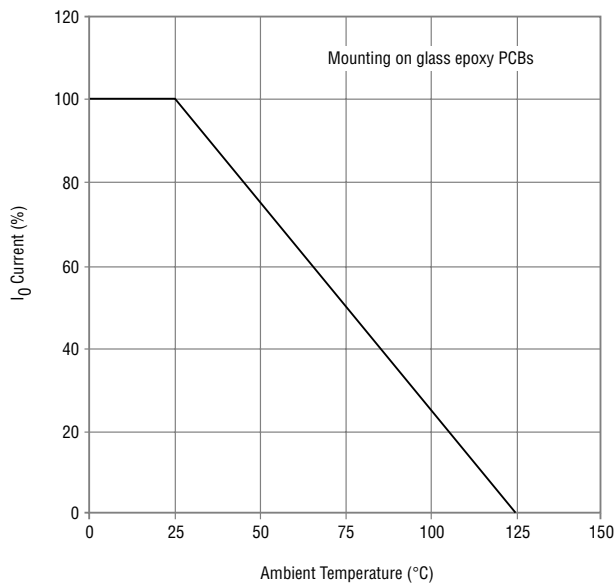
Forward Characteristics



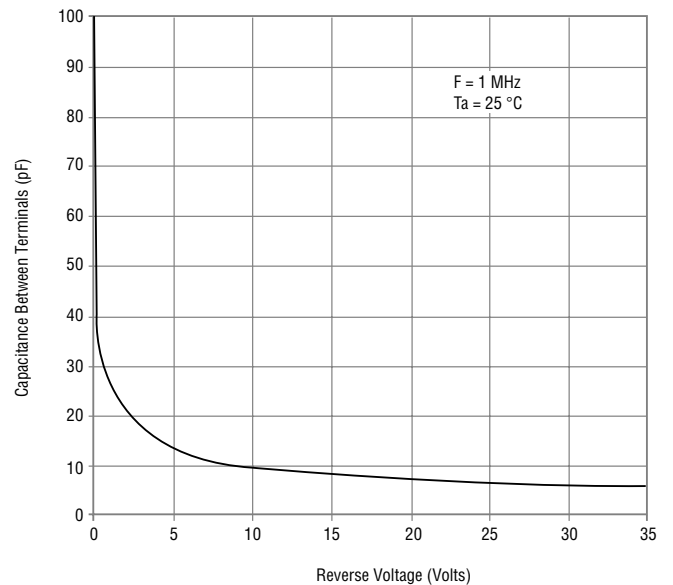
Reverse Characteristics



Derating Curve



Capacitance Between Terminals

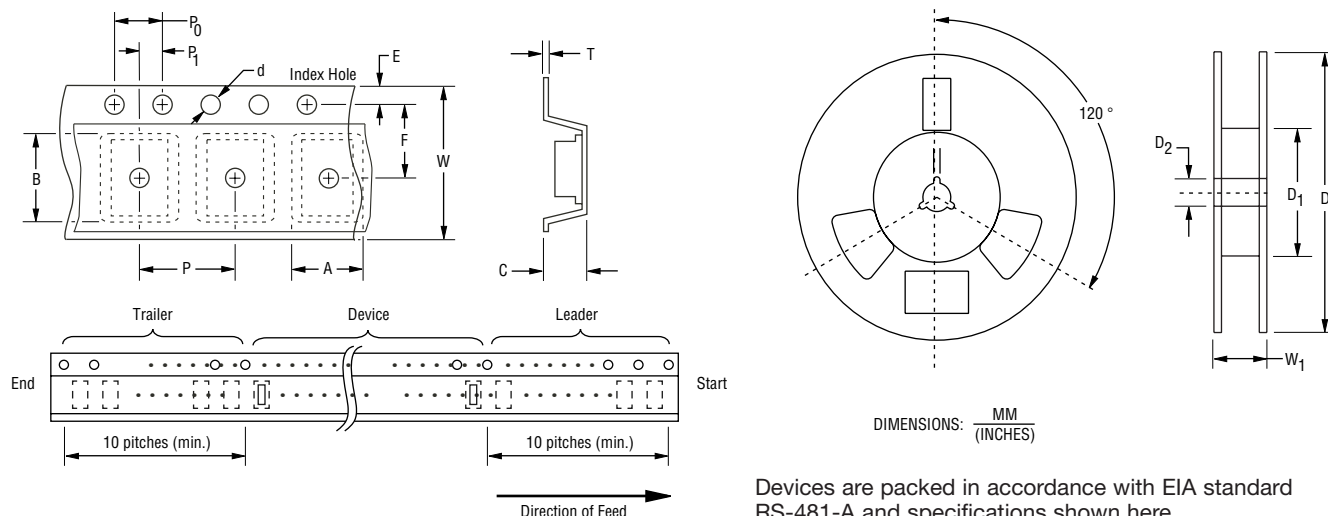


CD0603/1005 Schottky Barrier Chip Diode Series

BOURNS®

Packaging Information

The product will be dispensed in Tape and Reel format (see diagram below).



Devices are packed in accordance with EIA standard RS-481-A and specifications shown here.

Item	Symbol	0603	1005
Carrier Width	A	1.00 ± 0.10 (0.039 - 0.004)	1.55 ± 0.10 (0.061 - 0.004)
Carrier Length	B	1.85 ± 0.10 (0.073 - 0.004)	2.65 ± 0.10 (0.104 - 0.004)
Carrier Depth	C	1.00 ± 0.10 (0.039 - 0.004)	1.05 ± 0.10 (0.041 - 0.004)
Sprocket Hole	d	1.55 ± 0.05 (0.061 - 0.002)	1.55 ± 0.10 (0.061 - 0.004)
Reel Outside Diameter	D	178 (7.008)	178 (7.008)
Reel Inner Diameter	D ₁	60.0 (2.362) MIN.	60.0 (2.362) MIN.
Feed Hole Diameter	D ₂	13.0 ± 0.20 (0.512 - 0.008)	13.0 ± 0.20 (0.512 - 0.008)
Sprocket Hole Position	E	1.75 ± 0.10 (0.069 - 0.004)	1.75 ± 0.10 (0.069 - 0.004)
Punch Hole Position	F	3.50 ± 0.05 (0.138 - 0.002)	3.50 ± 0.05 (0.138 - 0.002)
Punch Hole Pitch	P	4.00 ± 0.10 (0.157 - 0.004)	4.00 ± 0.10 (0.157 - 0.004)
Sprocket Hole Pitch	P ₀	4.00 ± 0.10 (0.157 - 0.004)	4.00 ± 0.10 (0.157 - 0.004)
Embossment Center	P ₁	2.00 ± 0.05 (0.079 - 0.002)	2.00 ± 0.05 (0.079 - 0.002)
Overall Tape Thickness	T	0.20 ± 0.05 (0.008 - 0.002)	0.25 ± 0.05 (0.010 - 0.002)
Tape Width	W	8.00 ± 0.20 (0.315 - 0.008)	8.00 ± 0.20 (0.315 - 0.008)
Reel Width	W ₁	13.5 (0.531) MAX.	13.5 (0.531) MAX.
Quantity per Reel	--	4,000	4,000

REV. 12/15

Specifications are subject to change without notice.

Customers should verify actual device performance in their specific applications.